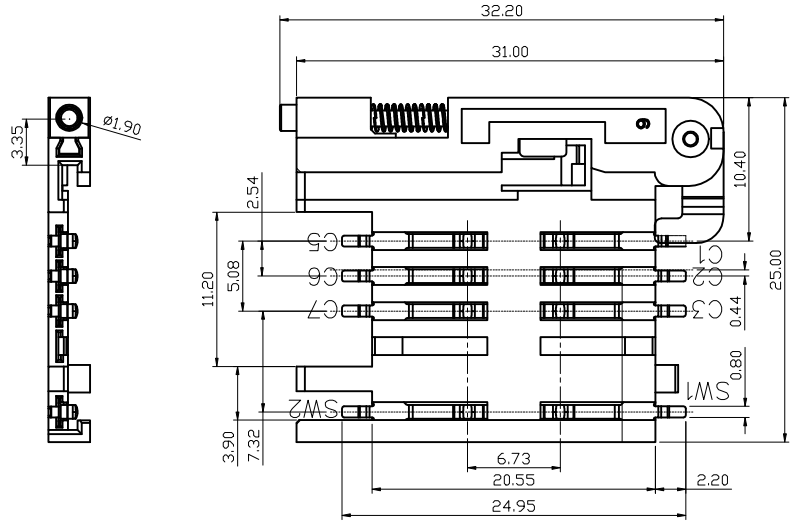
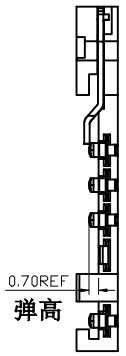
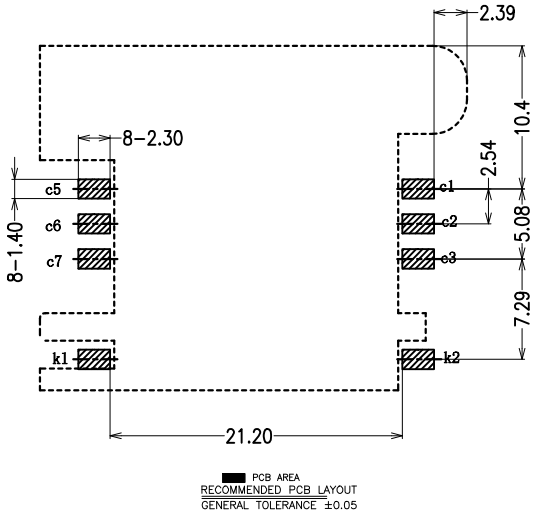
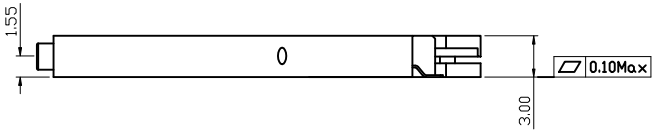
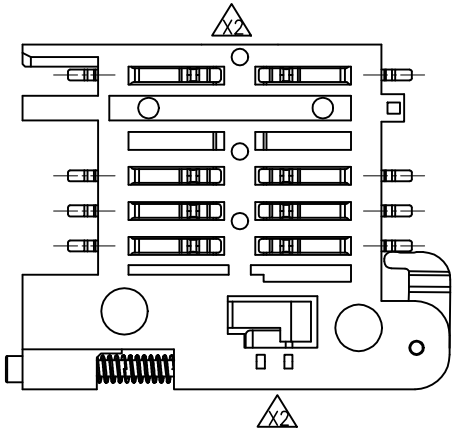
* 所有原料材质,生产制程,电镀必须符合ROHS 2.0要求

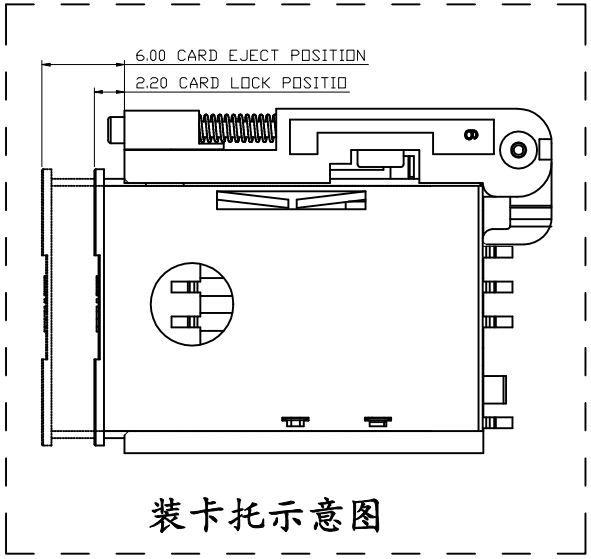












Specification

MATERIAL:

Insulator: High Temperature Thermoplastic,
(塑胶 黑色LCP，防火等级UL 94V-0)
帽子: PA9T UL 94V-0 Yellow
Contact: Copper Alloy(铜) T=0.15mm

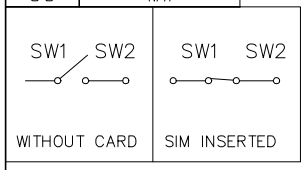
PLATING:

Contact: Plated 50u'' Ni Overall Contact Au G/F,pad TIN
(端子: 镍底50u,接触点G/F,焊点锡50u最少)

Electrical:

Current Rating :2Amps.max(额定电流:2A最大)
Voltage Rating :5V AC/DC(额定电压:5V AC/DC)
Ambient Temperature Range :-40° C~+85° C(工作温度：-40度到+85度)
Storage Temperature Range :-40° C~+85° C (工作环境：-40度到+85度)
Ambient Humidity Range :95% R.H. Max. (上锡效果：95%以上)
Contact Resistance:100mΩmax. (端子接触电阻：100m 最大)
Insulation Resistance:1000MΩmin./500VDC(绝缘阻抗：1000兆欧最小)
产品耐温温度：260度
Mating Cycles:5000Min Insertions (寿命：5000次)

PIN NO.	PIN NAME
	Supply Voltage Vcc
C2	Reset (RST)
C3	Clock (CLK)
C4	N/A
C5	Ground
C6	Programming Voltage Vpp
C7	I/O
C8	N/A



REVISION NO.	ECR NO.	DESCRIPTION	MARK	DATE
X2	----	主体底部加胶	Aaron	2024.06.20
X1	----	依实物修改图面	Aaron	2023.02.21
X0	----	NEW RELEASE	Aaron	2023.02.21

广东国连电子有限公司
GUANGDONG GUOLIAN ELECTRONICS CO.,LTD

DIMENSIONS INIT: mm
UNLESS OTHERWISE SPECIFIABLE

DIMENSION	TOLERANCE
X.X: ±	0.35
X.XX: ±	0.20
X.XXX: ±	0.10
ANGULAR: ±	2°

PRODUCT NAME : SIM CARD 抽屉式无柱(6P不带卡托)	DRAWING: Aaron	DATE: 2024.06.20	
PRODUCT NO. : SMB5FS1062E4	CHECK:	DATE:	
DRAWING NO. : D-SMB5FS1062E4	APPROVED:	DATE:	
	SCALE: 1:1	DWG ID: C D	REV.: X2 / PAGE: 1 OF 1